

Filename: Pro5206.tmp
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TID #: TIDA-00343

TIDA-00343 REV E1 Bill of Materials



| Item # | Designator | Quantity | Value | PartNumber | Manufacturer | Description | PackageReference |
|--------|------------------|----------|-------|-------------------|--------------|--|--------------------------|
| 1 | IPCB | 1 | | TIDA-00343 | Any | Printed Circuit Board | |
| 2 | D1, D2, D3, D4 | 4 | Green | LG L29K-G2J1-24-Z | OSRAM | LED, Green, SMD | 1.7x0.65x0.8mm |
| 3 | H1, H2, H3, H4 | 4 | | 4826 | Keystone | HEX STANDOFF 6-32 NYLON 1-3/4" | KEYSTONE 4826 |
| 4 | J1 | 1 | | 0015910100 | Molex | Header, 100mil, 5x2, SMT | Header, 100mil, 5x2, SMT |
| 5 | R1, R2, R3, R4 | 4 | 470 | CRCW0402470RJNED | Vishay-Dale | RES, 470, 5%, 0.063 W, 0402 | 0402 |
| 6 | FID1, FID2, FID3 | 0 | | N/A | N/A | Fiducial mark. There is nothing to buy or mount. | Fiducial |

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